

ProLight PBVL-17FWE-F5GR1
17W Power LED
Technical Datasheet
Version: 1.3

# **ProLight Opto ProEngine Series**

#### **Features**

- · High flux density of lighting source
- Good color uniformity
- · RoHS compliant
- More energy efficient than incandescent and most halogen lamps
- · Long lifetime
- · AEC-Q102 compliant
- SAE/ECE compliant

### **Main Applications**

- · Bicycle Lamps
- · Exterior Automotive Lighting
- · Floodlight
- · Bending Light
- · Daytime Running Light

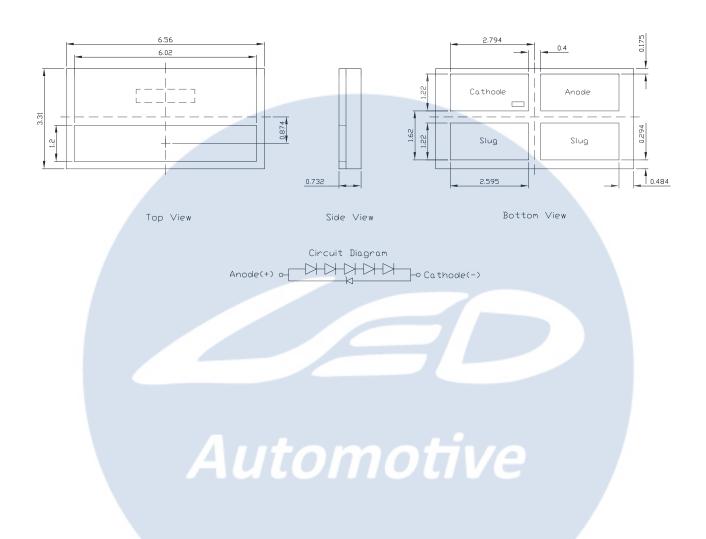
#### Introduction

• The input power is 17 Watt, the multi-chip ultra high power ProEngine Series delivers never before seen luminous flux output from a single emitter. The superficial illuminating nature of ProEngine makes them the preference bicycle lamps, typical applications include exterior automotive lighting Bending and Daytime Running Light.

Automotive



#### **Emitter Mechanical Dimensions**



#### Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm$  0.1mm.
- 4. Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

<sup>\*</sup>The appearance and specifications of the product may be modified for improvement without notice.



## Flux Characteristics, $T_j = 25^{\circ}C$

Radiation		Dowt Names or	Luminous Flux $\Phi_{V}$ (Im) @1000mA Refer @1		Flux Φ <sub>ν</sub> (lm)	Φ <sub>v</sub> (lm)	
	Color	Part Number			1200mA		
Pattern		Emitter	Min.	Тур.	Min.	Тур.	
Lambertian	White	PBVL-17FWE-F5GR1	1700	1950	2120	2230	

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

## **Electrical Characteristics, T<sub>J</sub> = 25°C**

		Forward Voltage V <sub>F</sub> (V)		Real Thermal	Electrical Thermal	
		@1000m <i>A</i>	λ	Refer @1200mA	Resistance Junction to	Resistance Junction to
Color	Min.	Тур.	Max.	Тур.	Slug (°C/W)	Slug (°C/W)
White	12.0	16.2	19.2	16.5	1.4	0.95

 $<sup>\</sup>bullet$  ProLight maintains a tolerance of  $\pm$  0.1V for Voltage measurements.

## Optical Characteristics at 1000mA, T<sub>J</sub> = 25°C

Radiation	Color	ITO Cole	or Temperature	сст	Angle (degrees)
Pattern	Coloi	Min.	Тур.	Max.	2 θ <sub>1/2</sub>
Lambertian	White	5380 K	5620 K	5860 K	120
		5620 K	5880 K	6140 K	120
		5870 K	6150 K	6430 K	120
		6140 K	6450 K	6760 K	120

<sup>•</sup> ProLight maintains a tolerance of ± 5% for CCT measurements.



### **Absolute Maximum Ratings**

White
1500
1500 (less than 1/10 duty cycle@1KHz)
150°C
175°C
-40°C - 125°C
-40°C - 125°C
Not designed to be driven in reverse bias
up to 8

Note: \* The LED chip exhibits excellent performance but slight package discoloration occurs at highest temperatures. Exemplary median lifetime for  $T_J = 175^{\circ}\text{C}$  is 100h.

#### **Photometric Luminous Flux Bin Structure**

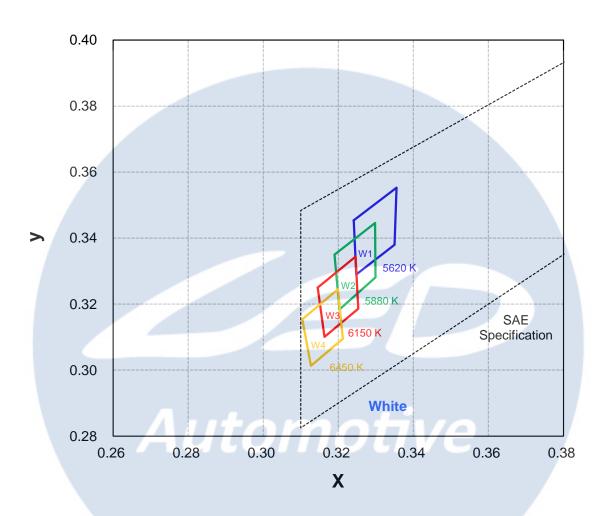
Color	Bin Code	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)	Available Color Bins
	F9	1700	1760	All
	FA	1760	1820	All
\\/hito	FB	1820	1880	All
White	FC	1880	2000	All
	FD	2000	2200	[1]
	FE	2200	2400	[1]

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- [1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order Possibility.



#### **Color Bin**

**White Binning Structure Graphical Representation** 



#### White Bin Structure

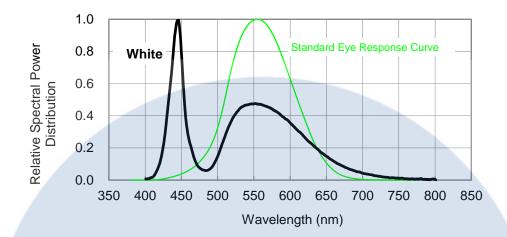
Bin Code	х	У	Typ. CCT (K)	Bin Code	х	У	Typ. CCT (K)
	0.3241	0.3241 0.3454		0.3145	0.3250		
W1	0.3248	0.3290	5620	W3	0.3163	0.3101	6150
V V I	0.3350	0.3380	3020	VVS	0.3253	0.3186	0130
	0.3355	0.3553			0.3246	0.3344	
	0.3190	0.3350			0.3104	0.3154	
W2	0.3203	0.3184	5880	W4	0.3127	0.3013	6450
VVZ	0.3299	0.3281	3000	V V <del>'4</del>	0.3212	0.3095	0430
	0.3298	0.3446			0.3199	0.3245	

• Tolerance on each color bin (x, y) is  $\pm 0.005$ 



## Color Spectrum, $T_1 = 25^{\circ}C$

1. White



Automotive



### **Junction Temperature Relative Characteristics**

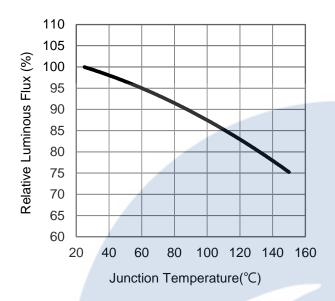


Fig 1. Junction Temperature vs.

Relative Luminous Flux at 1000mA.

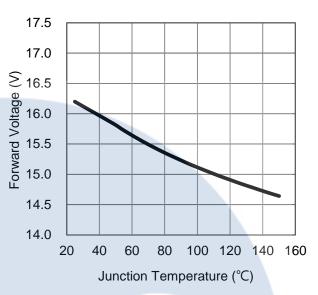


Fig 2. Junction Temperature vs. Forward Voltage at 1000mA.

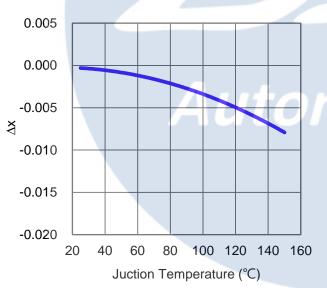


Fig 3. Junction Temperature vs. Chromaticity Coordinate  $\Delta x$  at 1000mA.

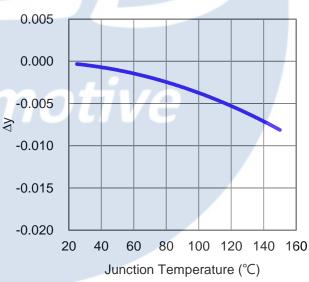


Fig 4. Junction Temperature vs. Chromaticity Coordinate  $\Delta y$  at 1000mA.



#### **Forward Current Relative Characteristics**

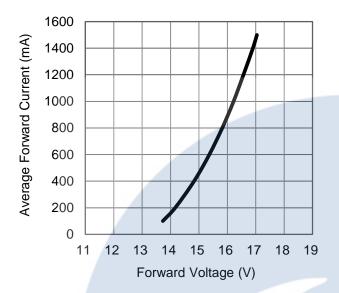


Fig 5. Forward Voltage vs. Forward Current at T<sub>1</sub>=25°C.

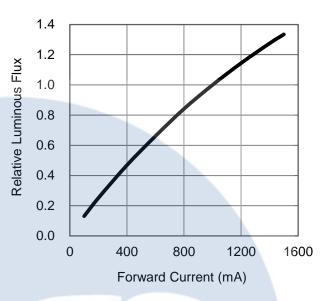


Fig 6. Forward Current vs. Relative Luminous Flux at  $T_J=25$ °C.

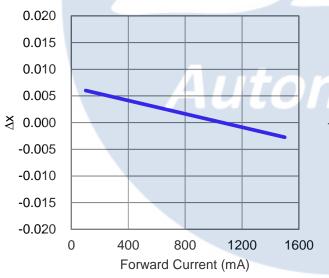


Fig 7. Forward Current vs. Chromaticity Coordinate  $\Delta x$  at  $T_J=25^{\circ}C$ .

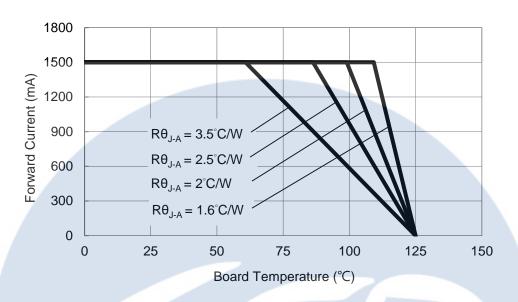


Fig 8. Forward Current vs. Chromaticity Coordinate  $\Delta y$  at  $T_J=25^{\circ}C$ .

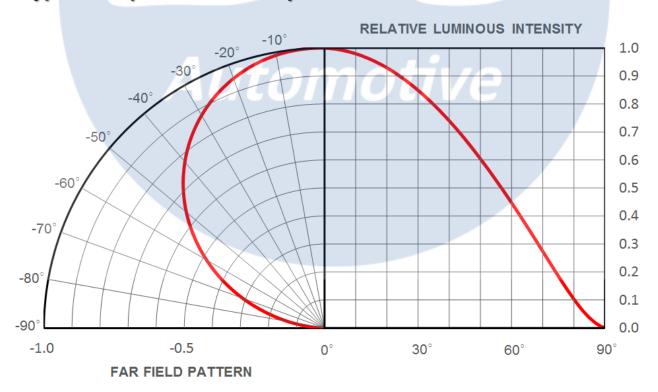


#### **Board Temperature vs. Maximum Forward Current**

**Maximum Forward Current** 



#### **Typical Representative Spatial Radiation Pattern**



2025/05 | DS-1738



### **Moisture Sensitivity Level – JEDEC Level 1**

			Soak Requirements			
Level	Floor Life		Stan	dard	Accelerated	Environment
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA

- The standard soak time includes a default value of 24 hours for semiconductor manufature's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

				Soak Req	uirements			
Level	Floor Life		Stan	dard	Accelerated	Accelerated Environment		
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions		
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA		
2	1 year	≤30°C / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA		
2a	4 weeks	≤30°C / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH		
3	168 hours	≤30°C / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH		
4	72 hours	≤30°C / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH		
5	48 hours	≤30°C / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH		
5a	24 hours	≤30°C / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH		
6	Time on Label (TOL)	≤30°C / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA		



#### Reliability testing in accordance with AEC-Q102

The development of this product included extensive operational life-time testing and environmental testing. Table 1 summarizes the tests applied and cumulative test results obtained from testing performed in accordance with AEC-Q102.

Table 1. Operating life, mechanical and environmental tests performed on it's package in accordance with AEC-Q102.

#	STRESS	ABV	Conditions	Duration	Failure Criteria	Rejects
1	Pre- and Post-Stress Electrical Test	TEST	Test is performed as specified in the applicable stress reference at room temperature.	N/A	See notes [2]	0
<u>A1</u>	Pre-conditioning	PC	Soak Tamb = 85 °C, RH = 85% Reflow soldering	N/A	See notes [2]	0
<u>A2a</u>	Wet High Temperature Operating Life	WHTOL 1	Tambient = 85 °C / 85% RH IF = max. DC [1]	1000 hours	See notes [2]	0
<u>A3a</u>	Power Temperature Cycling	PTC	-40°C to 85°C, 10 minutes dwell, 20 minutes transfer (1 hour cycle), 2 minutes ON/2 minutes OFF, IF = max. DC [1]	1000 hours	See notes [2]	0
<u>A4</u>	Temperature Cycling	TC	-40°C to 125°C,15 minutes dwell	1000 cycles	See notes [2]	0
<u>B1a</u>	High Temperature Operating Life	HTOL1	Tsolder =85°C, IF = max. DC [1]	1000 hours	See notes [2]	0
<u>B1b</u>	High Temperature Operating Life	HTOL2	Maximum specified Tsolder, IF = max. DC [1]	1000 hours	See notes [2]	0
<u>C9</u>	Thermal Resistance	TR	All qualification parts submitted for testing	N/A	See notes [2]	0
C10	Solderability	SD	245 °C ± 5 °C	3s	See notes [3]	0
<u>C12</u>	Hydrogen Sulphide	H2S	Corrosion class A: (preferred) Duration 336 h at 40 °C and 90% RH. H2S concentration: 15ppm	336 hours	See notes [2]	0
<u>E3</u>	Electrostatic Discharge Human Body Model	НВМ	ANSI/ESDA/JEDEC JS-001	N/A	See notes [3]	0
<u>G2</u>	Vibration Variable Frequency	VVF	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis	N/A	See notes [3]	0
<u>G3</u>	Mechanical Shock	MS	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis	N/A	See notes [3]	0

#### Notes:

1. Depending on the maximum derating curve.

2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement						
item	rest Condition	Min.	Max.					
Forward Voltage (V <sub>F</sub> )	$I_F = max DC$	-	Initial Level x 1.1					
Luminous Flux or	I <sub>F</sub> = max DC	Initial Level x 0.8						
Radiometric Power (Φ <sub>V</sub> )	1,	a. 20101 X 010						
Reverse Current (I <sub>R</sub> )	$V_R = 5V$	-	50 µA					
* ( ) (	The state of the s							

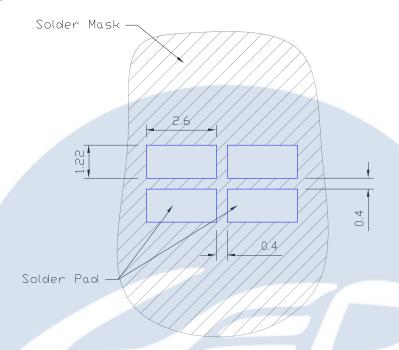
<sup>\*</sup> The test is performed after the LED is cooled down to the room temperature.

<sup>3.</sup> A failure is an LED that is open or shorted.



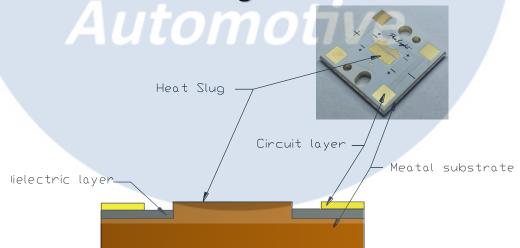
## **Recommended Solder Pad Design**

**Standard Emitter** 



All dimensions are in millimeters.

## **Recommended MCPCB Design**

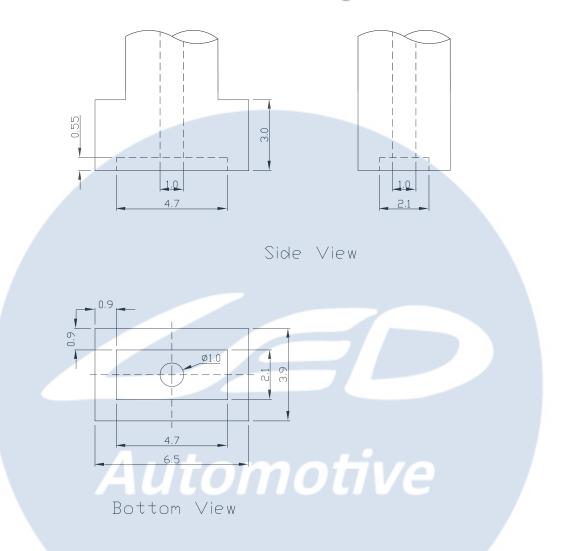


- Copper(Cu) substrate is recommended.
- The thermal conductivity of dielectric layer in the Aluminum(Al) substrate is greater or equal than 6w/mk.
- If the thermal conductivity of dielectric layer equal to 2w/mk, the power consumption should be lower than 20w.

2025/05 DS-1738



## **Recommended Suction Nozzle Design**



#### Notes:

- 1. All dimensions are in millimeters and tolerances are  $\pm$  0.05mm.
- 2. Recommended the material of suction nozzle was PEEK.
- 3. The actual suction nozzle like below picture.



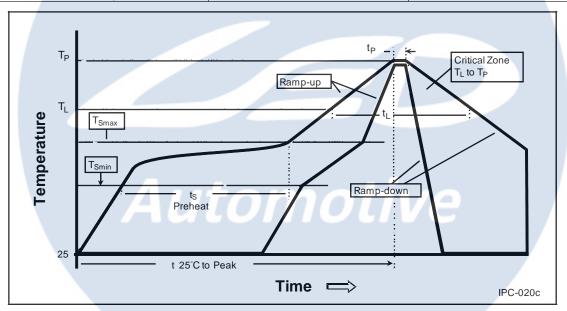


2025/05 | DS-1738



#### **Reflow Soldering Condition**

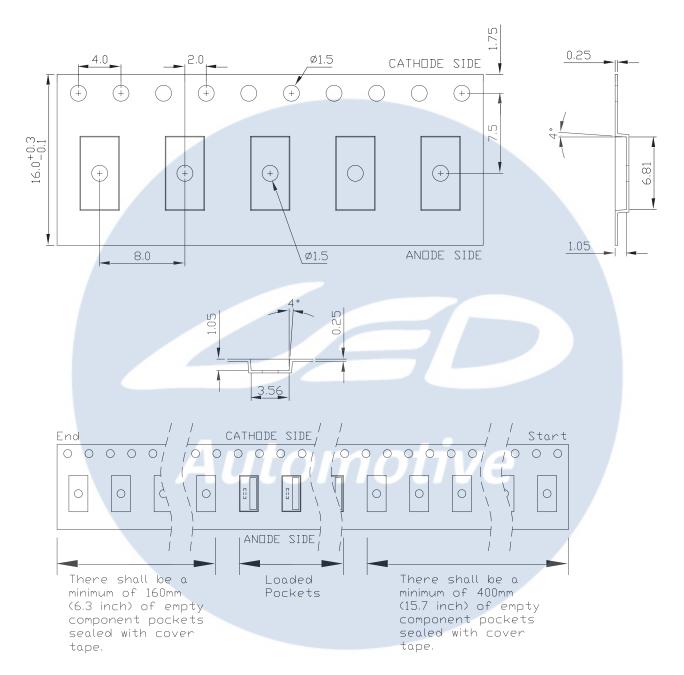
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate	3°C / second max.	3°C / second max.
(T <sub>Smax</sub> to T <sub>P</sub> )	3 C/ Second max.	3 C/ Second Max.
Preheat		
<ul><li>– Temperature Min (T<sub>Smin</sub>)</li></ul>	100°C	150°C
<ul><li>Temperature Max (T<sub>Smax</sub>)</li></ul>	150°C	200°C
– Time (t <sub>Smin</sub> to t <sub>Smax</sub> )	60-120 seconds	60-180 seconds
Time maintained above:		
– Temperature (T <sub>L</sub> )	183°C	217°C
– Time (t <sub>1</sub> )	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T <sub>P</sub> )	240°C	260°C
Time Within 5°C of Actual Peak	10-30 seconds	20-40 seconds
Temperature (t <sub>p</sub> )	To-so seconds	20-40 Seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind
  of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a
  double-head soldering iron should be used. It should be confirmed beforehand whether the
  characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



### **Emitter Reel Packaging**



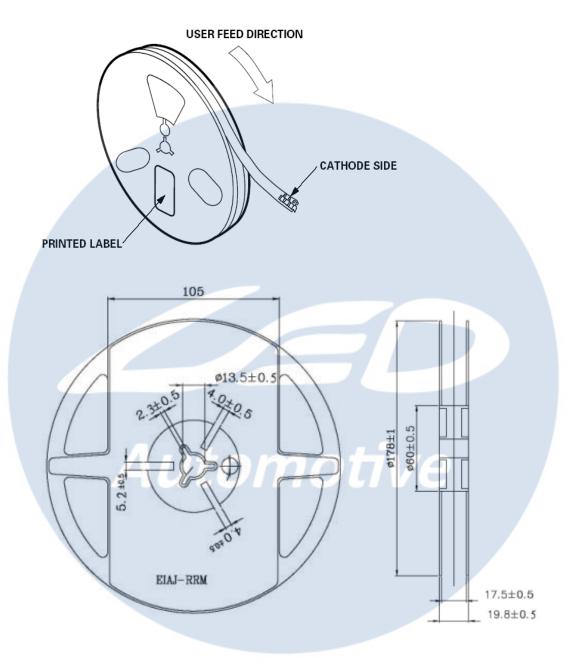
#### Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm$  0.1mm.

2025/05 DS-1738



### **Emitter Reel Packaging**



#### Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 500 or 1000 pieces per reel.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.



#### **Recommended Soldering Condition**

- Please use lead free and "no clean" solders.
- Soldering shall be implemented using a soldering tip at a temperature lower than 350 °C, and shall be finished within 3.5 seconds for each pad.
- During the soldering process, put the LEDs on materials whose conductivity is poor enough not to radiate heat of soldering.
- Properly solder tin wires before soldering them to LEDs.
- Avoid touching the glass lens with the soldering iron.
- Please prevent flux from touching to the glass lens.
- Please solder evenly on each pad.
- Contacts number of a soldering tip should be within twice for each pad.
- Next process of soldering should be carried out after the LEDs have return to ambient temperature.
- \*ProLight cannot guarantee if usage exceeds these recommended conditions.

  Please use it after sufficient verification is carried out on your own risk if absolutely necessary.

#### **Precaution for Use**

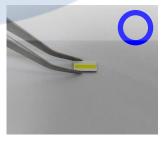
- The modules light output are intense enough to cause injury to human eyes if viewed directly.
   Precautions must be taken to avoid looking directly at the modules with unprotected eyes.
- The modules are sensitive to electrostatic discharge. Appropriate ESD protection measures
  must be taken when working with the modules. Non-compliance with ESD protection
  measures may lead to damage or destruction of the product.
- Chemical solvents or cleaning agents must not be used to clean the modules.
   Mechanical stress on the Emitters must be avoided. It is best to use a soft brush, damp cloth or low-pressure compressed air.
- The products should be stored away from direct light in dry location.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/

## **Handling of without Cover Lens LEDs**

Notes for handling of without cover lens LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the emitting area, otherwise it will cause a catastrophic failure.
- Avoid touching the emitting area especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the emitting area .
- Please store the LEDs away from dusty areas or seal the product against dust.
- Please do not mold over the emitting area with another resin. (epoxy, urethane, etc)







#### **Disclaimers**

ProLightopto Technology has made every reasonable effort to ensure the accuracy of the information in this datasheet. However, it should be understood that this information is for guidance only and does not constitute any offer or part of a contract.

ProLightopto Technology does not guarantee or accept any legal liability for the accuracy, completeness, or usefulness of any information, product, technology, or process disclosed in this datasheet. The company reserves the right to make changes or improvements to this datasheet at its discretion.

Unless this datasheet is incorporated into a formal contract, customers should not rely on the information as a binding commitment to any specifications or product parameters by ProLightopto Technology. Customers are advised to verify that the information is current and complete before entering into any contract or acknowledging any purchase order. Therefore, all products described herein are subject to ProLightopto Technology's terms and conditions at the time of order acknowledgment.

Unless agreed upon by contractual agreement, not all parameters of each product are necessarily tested. ProLightopto Technology does not warrant or grant any license, either expressed or implied, under its patent rights or the rights of others.

Reproduction of the information contained herein is permitted only if done without any modifications or alterations. Altering this information and reproducing it is considered an unfair and deceptive business practice. ProLightopto Technology is not responsible or liable for any such altered documentation.

Reselling ProLightopto Technology's products with statements that differ from or exceed the parameters specified by ProLightopto Technology voids all express or implied warranties for the associated product or service and is considered an unfair and deceptive business practice. ProLightopto Technology is not responsible or liable for any such statements.

ProLightopto Technology's products are not authorized for use as critical components in life support devices or systems without explicit written approval from ProLightopto Technology.

For the purposes of this disclaimer:

- 1. Life support devices or systems are defined as those intended for surgical implant into the body or those that support or sustain life. Their failure, when used according to instructions for use provided in the labeling, can reasonably be expected to result in significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure can reasonably be expected to cause the failure of the device or system, or to affect its safety or effectiveness.